

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









5 A Schottky Barrier Rectifier

DESCRIPTION

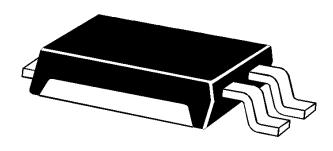
In Microsemi's new Powermite[®] SMT package, these high efficiency Schottky rectifiers offer the power handing capabilities previously found only in much larger packages. They are ideal for SMD applications that operate at high frequencies.

In addition to its size advantages, Powermite® package features include a full metallic bottom that eliminates the possibility of solder flux entrapment during assembly, and a unique locking tab acts as an integral heat sink. Its innovative design makes this device ideal for use with automatic insertion equipment.

IMPORTANT: For the most current data, consult *MICROSEMI*'s website: http://www.microsemi.com

| ABSOLUTE MAXIMUM RATINGS AT 25° C (UNLESS OTHERWISE SPECIFIED) | | | | | | | |
|---|--|-------------|------|--|--|--|--|
| Rating | Symbol | Value | Unit | | | | |
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 60 | V | | | | |
| RMS Reverse Voltage | V _R (RMS) | 42 | V | | | | |
| Average Rectified Output Current | lo | 5 | Α | | | | |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine wave Superimposed on Rated Load@ T _c =90 °C | I _{FSM} | 100 | А | | | | |
| Storage Temperature | T _{STG} | -55 to +150 | °C | | | | |
| Junction Temperature | Т. | -55 to +125 | °C | | | | |

| THERMAL CHARAC | TERISTICS | 5 | | | | | | |
|------------------------------|---------------------------|-----|---------|--|--|--|--|--|
| (UNLESS OTHERWISE SPECIFIED) | | | | | | | | |
| Thermal Resistance | | | | | | | | |
| Junction-to Tab | $R_{	heta \mathrm{JTAB}}$ | 7.5 | °C/Watt | | | | | |
| Junction-to Bottom | $R_{	heta JC}$ | 2.5 | °C/Watt | | | | | |

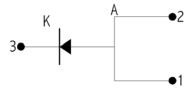


KEY FEATURES

- High power surface mount package
- Guard Ring die construction for transient protection
- Internal heat sink locking tabs
- Low forward voltage
- Full metallic bottom eliminates flux entrapment
- Compatible with automatic insertion equipment
- Low profile-maximum height of 1mm supplied in 16 mm tape reel- 5000 units/ 13" reel.

APPLICATIONS/BENEFITS

- Switching and Regulating Power Supplies
- Silicon Schottky (hot carrier) rectifier for minimal reverse voltage recovery
- Elimination of reverse-recovery oscillations to reduce need for EMI filtering
- Charge Pump Circuits
- Reduces reverse recovery loss due to low I_{RM}
- Small foot print
 190 X 270 mils (1:1 Actual size)
 See mounting pad details on pg 4





5 A Schottky Barrier Rectifier

| ELECTRICAL PARAMETERS @ 25°C (unless otherwise specified) | | | | | | | | | |
|---|-----------------|--|-----|------------------------------|------------------------------|----------|--|--|--|
| Parameter | Symbol | Conditions | Min | Тур. | Max | Units | | | |
| Forward Voltage (Note 1) | V _{Fm} | $I_F = 5 \text{ A}$, $T_j = 25 \text{ °C}$ $I_F = 5 \text{ A}$, $T_j = 125 \text{ °C}$ $I_F = 8 \text{ A}$, $T_j = 25 \text{ °C}$ $I_F = 8 \text{ A}$, $T_j = 125 \text{ °C}$ | | 0.65 0.56 0.74 0.64 | 0.69 0.60 0.78 0.68 | V | | | |
| Reverse Break Down Voltage (Note 1) | V_{BR} | I _R = 0.2 mA | 60 | | | V | | | |
| Reverse Current (Note1) | I _m | V _R = 60 V, T _j = 25°C V _R = 60 V, T _j = 125 °C | | 2 0.6 | 200 20 | μA mA | | | |
| Capacitance | Ст | $V_R = 4 \text{ V}; F = 1 \text{ MH}_Z$ | | 150 | | pF | | | |

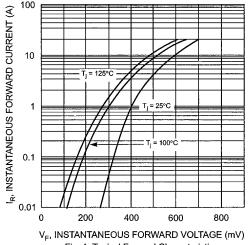
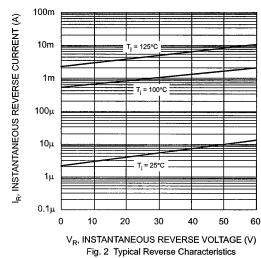


Fig. 1 Typical Forward Characteristics



Note: 1 Short duration test pulse used to minimize self – heating effect.

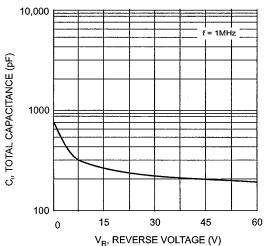
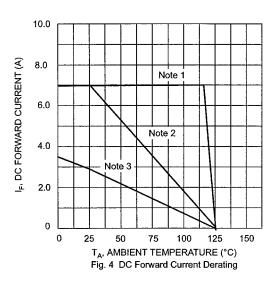
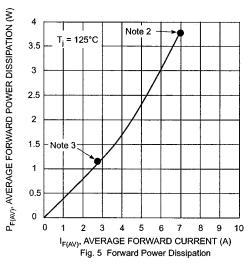


Fig. 3 Typical Capacitance vs. Reverse Voltage



5 A Schottky Barrier Rectifier



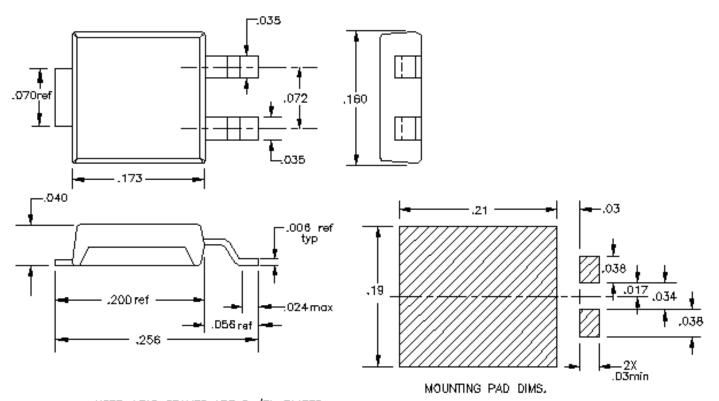


- NOTE 1: T_A = T_C at case bottom where $R_{\theta JC}$ =2.5° C/W and $R_{\theta CA}$ = 0° C/W (infinite heat sink).
- NOTE 2: Device mounted on GETEK substrate, 2" x 2", 2 oz. copper , double-sided , cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". $R_{\theta JA}$ in range of 20-35° C/W.
- NOTE 3: Device mounted on FRA-4 substrate, 2" x 2", 2 oz. copper, single-sided, pad layout R_{0JA} in range of 75 100° C/W.

PRODUCT PRELIMINARY DATA – Information contained in this document is pre-production data, and is proprietary to Microsemi Corp. It may not be modified in any way without the express written consent of Microsemi Corp. Product referred to herein is not guaranteed to achieve preliminary or production status and product specifications, configurations, and availability may change at any time.



5 A Schottky Barrier Rectifier





5 A Schottky Barrier Rectifier

NOTES: